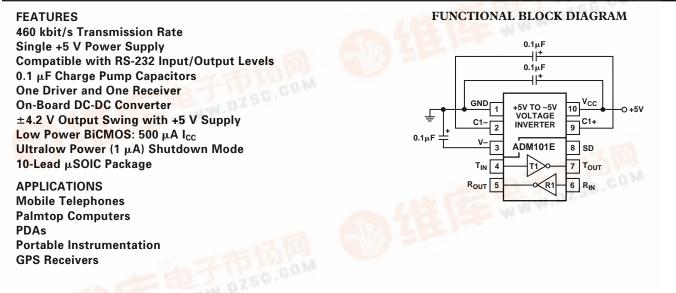
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## Craft Port<sup>™</sup> Tiny RS-232 Transceiver for Portable Applications

# ADM101E



#### **GENERAL DESCRIPTION**

The ADM101E is a single channel RS-232 driver and receiver in the Analog Devices Craft Port series, designed to operate from a single, +5 V supply. A highly efficient charge-pump voltage inverter generates an on-chip -5 V supply, which eliminates the need for a negative power supply for the driver and permits RS-232 compatible output levels to be developed using charge pump capacitors as small as 0.1  $\mu$ F.

A shutdown input disables the charge pump and puts the device into a low power shutdown mode, in which the current consumption is typically less than 1  $\mu$ A. The transmitter is disabled during shutdown but the receiver remains functional. An epitaxial BiCMOS construction minimizes power consumption to 3 mW and also guards against latch-up. Overvoltage protection is provided allowing the receiver inputs to withstand continuous voltages in excess of  $\pm 30$  V. In addition, all I-O pins have ESD protection to levels greater than 15 kV.

The ADM101E is available in a 10-lead  $\mu$ SOIC package, which makes it ideal for serial communications in small, portable applications such as palmtop computers and mobile telephones, where a full, RS-232 serial interface is not required, but compact size and low power drain are paramount.

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REV ODF

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## $\label{eq:ADM101E} ADM101E - SPECIFICATIONS \begin{array}{l} (V_{\text{CC}} = +5 \ \text{V} \pm 10\%, \ \text{C1} = \text{C2} = 0.1 \ \mu\text{F}. \ \text{All specifications } T_{\text{MIN}} \ \text{to } T_{\text{MAX}} \ \text{unless otherwise noted.} \end{array}$

Parameter	Min	Тур	Max	Units	Test Conditions/Comments
Output Voltage Swing	±3.5	$\pm 4.2$		V	$V_{CC} = 5 V \pm 5\%$ , $T_{OUT}$ Loaded with 3 k $\Omega$ to GND
	±3.25	$\pm 4.2$		V	$V_{CC} = 5 V \pm 10\%$ , $T_{OUT}$ Loaded with 3 k $\Omega$ to
					GND
V <sub>CC</sub> Power Supply Current (Unloaded)		0.5	1	mA	No Load, $T_{IN} = V_{CC}$ or GND
V <sub>CC</sub> Power Supply Current (Loaded)		1.85	2.5	mA	$T_{OUT}$ Loaded with 3 k $\Omega$ to GND
V <sub>CC</sub> Power Supply Current (Shutdown)			1	μA	SD Input = $V_{CC}$
Input Logic Threshold Low, V <sub>INL</sub>			0.8	V	
Input Logic Threshold High, V <sub>INH</sub>	2.4			V	
Input Leakage Current			$\pm 1$	μA	
RS-232 Input Voltage Range	-15		+15	V	
RS-232 Input Threshold Low	0.8	2.2		V	
RS-232 Input Threshold High		2.4	2.6	V	
RS-232 Input Hysteresis		0.2		V	
RS-232 Input Resistance	3	5	7	kΩ	
TTL/CMOS Output Voltage Low, V <sub>OL</sub>			0.4	V	$I_{OUT} = 1.6 \text{ mA}$
TTL/CMOS Output Voltage High, V <sub>OH</sub>	3.5			V	$I_{OUT} = -1.0 \text{ mA}$
Propagation Delay		0.25		μs	RS-232 to TTL
Instantaneous Slew Rate <sup>1</sup>		25		V/µs	$C_{L} = 10 \text{ pF}, R_{L} = 3 \text{ k}\Omega - 7 \text{ k}\Omega, T_{A} = +25^{\circ}\text{C}$
Transition Region Slew Rate		11		V/µs	$R_{\rm L} = 3 \text{ k}\Omega, C_{\rm L} = 1000 \text{ pF}$
					Measured from +3 V to -3 V or Vice Versa
Baud Rate	460			kB	$R_L = 3 k\Omega, C_L = 1 nF$
Output Resistance	300			Ω	$V_{CC} = 0 V, V_{OUT} = \pm 2 V$
RS-232 Output Short Circuit Current		±25	$\pm 60$	mA	

#### NOTES

<sup>1</sup>Sample tested to ensure compliance.

Specifications subject to change without notice.

#### ABSOLUTE MAXIMUM RATINGS\*

$(T_A = +25^{\circ}C \text{ unless otherwise noted})$	
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V <sub>CC</sub>
Input Voltages
Driver Input $T_{IN}$
Receiver Input $R_{IN}$ ±30 V
Output Voltages
Driver Output $T_{OUT}$ $(V_{CC}, +0.3 \text{ V})$ to $(V_{-}, -0.3 \text{ V})$
Receiver Output $R_{OUT}$ 0.3 V to (V <sub>CC</sub> +0.3 V)
Short Circuit Duration
T <sub>OUT</sub> Continuous
Power Dissipation
RM-10 (Derate 12 mW/°C Above +70°C) $\dots 1488 \text{ mW}$
Thermal Impedance
Operating Temperature Range
Industrial (A Version) $\dots -40^{\circ}$ C to $+85^{\circ}$ C
Storage Temperature Range $\dots -65^{\circ}C$ to $+150^{\circ}C$
Lead Temperature Soldering
Vapor Phase (60 sec)+215°C
Infrared (15 sec)+220°C
ESD Rating
ESD Rating (I-O Pins) 15 kV

\*This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

#### **ORDERING GUIDE**

Model	Temperature	Package	Package
	Range	Description	Option
ADM101EARM	$-40^{\circ}$ C to $+85^{\circ}$ C	μSOIC	RM-10

### ADM101E

PIN FUNCTION DESCRIPTION				
Pin No.	Mnemonic	Function		
1	GND	Ground Pin. Must be connected to 0 V.		
2	C1-	Negative Terminal of C1 (if C1 is Polarized Capacitor).		
3	V–	Internally Generated Negative Supply Voltage.		
4	$T_{\rm IN}$	Driver Input (3 V to 5 V TTL/CMOS Logic Levels).		
5	R <sub>OUT</sub>	Receiver Output (3 V to 5 V TTL/CMOS Logic Levels).		
6	R <sub>IN</sub>	Receiver Input (EIA-232 Signal Levels).		
7	T <sub>OUT</sub>	Driver Output (EIA-232 Signal Levels).		
8	SD	Shutdown Input. Logic 1 on this input puts the ADM101E into low power shutdown mode.		
9	C1+	Positive Terminal of Charge Pump Capacitor (if C1 is Polarized Capacitor).		
10	$V_{CC}$	Positive Power Supply, Nominally +5 V.		

## **Typical Performance Characteristics**

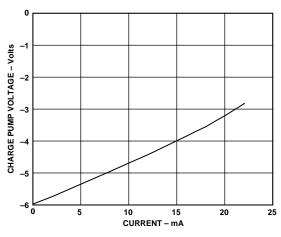
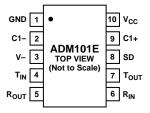


Figure 1. Charge Pump Voltage vs. Current

#### PIN CONFIGURATION



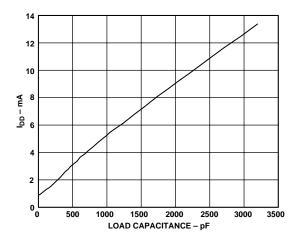
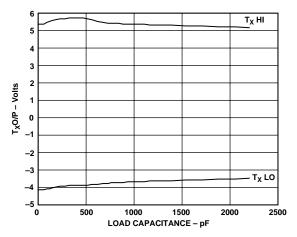


Figure 2. I<sub>DD</sub> vs. Load Capacitance @ 460 kbps

### ADM101E



*Figure 3. Transmitter Output Voltage vs. Load Capacitance* @ 460 kbps

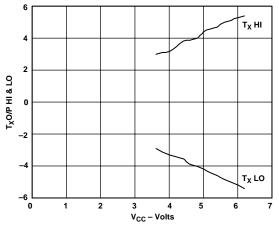


Figure 4. Tx Output Voltage vs. Supply

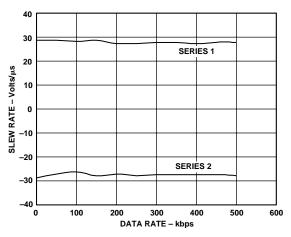


Figure 5. Slew Rate vs. Data Rate

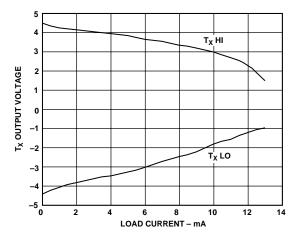


Figure 6. Transmitter Output Voltage vs. Load Current

#### **GENERAL DESCRIPTION**

The ADM101E is an RS-232 compatible line driver/receiver in the Analog Devices Craft Port series, containing one driver (transmitter) and one receiver. It is ideal for serial communication in small portable devices such as mobile telephones, palmtop personal computers and personal digital assistants, where a full, RS-232 serial interface is not required, and only Tx and Rx lines are required for low speed communication between devices. The ADM101E operates from a single, +5 V supply, and generates its own, on-chip, -5 V power supply, thus removing the need for a negative power supply for the driver.

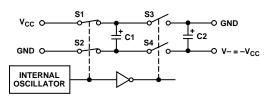
#### CIRCUIT DESCRIPTION

The internal circuitry consists of three main sections. These are:

- 1. A charge pump dc-to-dc converter.
- 2. 5 V logic to EIA-232 driver.
- 3. EIA-232 to 5 V logic receiver.

#### Charge Pump DC-DC Converter

The dc-dc converter generates a negative supply voltage from the +5 V supply, thus removing the need for a separate -5 V rail. It consists of an on-chip 200 kHz oscillator, switching matrix and two external capacitors, as shown in Figure 7.



#### Figure 7. Charge Pump DC–DC Converter

When S1 and S2 are closed, S3 and S4 are open, and C1 charges to  $+V_{CC}$ . S1 and S2 are then opened, while S3 and S4 are closed to connect C1 across C2, dumping charge into C2. Since the positive terminal of C2 is at ground, a negative voltage will be built up on its negative terminal with each cycle of the oscillator. This voltage depends on the current drawn from C2. If the current is small, the voltage will be close to  $-V_{CC}$ , but will fall as the current drawn increases.

#### **Charge Pump Capacitors And Supply Decoupling**

For proper operation of the charge pump, the capacitors should have an equivalent series resistance (ESR) less than 1  $\Omega$ . As the charge pump draws current pulses from V<sub>CC</sub>, the V<sub>CC</sub> decoupling capacitor should also have low ESR. The V<sub>CC</sub> decoupling capacitor and V– reservoir capacitor should also have low ESR because they determine how effectively ESD pulses are clamped to V<sub>CC</sub> or V– by the on-chip clamp diodes. Tantalum or monolithic ceramic capacitors are suitable for these components. If using tantalum capacitors, do not forget to observe polarity.

#### Transmitter (Driver) Section

The driver converts 5 V logic input levels into RS-232 compatible output levels. With  $V_{CC}$  = +5 V and driving an EIA-232 load, the output voltage swing is typically ±4.2 V.

#### **Receiver Section**

The receivers are inverting level-shifters that accept EIA-232 input levels and translate them into 5 V logic output levels. The inputs have internal 5 k $\Omega$  pull-down resistors to ground and are also protected against overvoltages of up to  $\pm 25$  V. The guaranteed switching thresholds are 0.8 V minimum and 2.8 V maximum. An unconnected receiver input is pulled to 0 V by the internal 5 k $\Omega$  pull-down resistor. This, therefore, results in a Logic 1 output level for unconnected inputs or for inputs connected to GND.

The receivers have Schmitt trigger input with a hysteresis level of 0.25 V. This ensures error-free reception for both noisy inputs and for inputs with slow transition times.

#### SHUTDOWN INPUT

The shutdown input allows the ADM101E to be put into an ultralow power mode where the dc-dc converter is switched off and the transmitter is disabled. The receiver remains active during shutdown. Logic 0 at this input enables the ADM101E, while a Logic 1 at this input shuts down the ADM101E.

### **ADM101E**

### ADM101E

#### **OUTLINE DIMENSIONS**

Dimensions shown in inches and (mm).

#### 10-Lead µSOIC (RM-10)

